## : ©hipsmall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts,Customers Priority,Honest Operation, and Considerate Service",our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!


## Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832
Email \& Skype: info@chipsmall.com Web: www.chipsmall.com Address: A1208, Overseas Decoration Building, \#122 Zhenhua RD., Futian, Shenzhen, China


## The Future of Analog IC Technology

## DESCRIPTION

The MP18024 is a high-frequency, 100V, halfbridge, N-channel, power MOSFET driver. Its lowside and high-side driver channels are independently controlled and matched with less than 5 ns in time delay. Under-voltage lockout on both high-side and low-side supplies force their outputs low in case of insufficient supply. The integrated bootstrap diode reduces external component count.

## FEATURES

- Drives an N-Channel MOSFET Half Bridge
- $100 \mathrm{~V} \mathrm{~V}_{\text {BST }}$ Voltage Range
- On-Chip Bootstrap Diode
- Typical Propagation Delay of 20ns
- Gate Drive Matching Of Less Than 5ns
- Drives A 2.2nf Load with 15 nm Rise Time and 12ns Fall Time at12v VDD
- TTL-Compatible Input
- Quiescent Current of Less Than $150 \mu \mathrm{~A}$
- UVLO for Both High Side and Low Side
- SOIC8E Package


## APPLICATIONS

- Telecom Half-Bridge Power Supplies
- Avionics DC-DC Converters
- Two-Switch Forward Converters
- Active-Clamp Forward Converters

For MPS green status, please visit MPS website under Quality Assurance. "MPS" and "The Future of Analog IC Technology" are Registered Trademarks of Monolithic Power Systems, Inc.

## TYPICAL APPLICATION



ORDERING INFORMATION

| Part Number* | Package | Top Marking |
| :---: | :---: | :---: |
| MP18024HN | SOIC8E | MP18024HN |

* For Tape \& Reel, add suffix -Z (e.g. MP18024HN-Z);

For RoHS compliant packaging, add suffix -LF; (e.g. MP18024HN-LF-Z)
PACKAGE REFERENCE

ABSOLUTE MAXIMUM RATINGS ..... (1)
Supply Voltage (VD) -0.3 V to +18 V
SW Voltage ( $\mathrm{V}_{\mathrm{Sw}}$ ) ..... -5.0 V to +105 V
BST Voltage ( $\mathrm{V}_{\mathrm{BST}}$ ) ..... -0.3 V to +118 V
BST to SW ..... -0.3 V to +18 V
DRVH to SW

$\qquad$
-0.3 V to (BST-SW) +0.3 V

DRVL to VSS
$\qquad$
-0.3 V to (VDD +0.3 V )
All Other Pins -0.3 V to $\left(\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}\right)$
Continuous Power Dissipation ..... $\left(\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}\right)$ ..... (2) ..... 2.6W
Junction Temperature ..... $150^{\circ} \mathrm{C}$
Lead Temperature ..... $260^{\circ} \mathrm{C}$
Storage Temperature

$\qquad$
$-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Recommended Operating Conditions ${ }^{(3)}$
Supply Voltage VDD ......................9.0V to 16.0V
SW Voltage ( $\mathrm{V}_{\mathrm{sw}}$ ) .........................-1.0V to 100 V
SW Slew Rate...................................... $<50 \mathrm{~V} / \mathrm{ns}$
Operating Junction Temp. ( $\mathrm{T}_{\mathrm{J}}$ ). $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$


## Notes:

1) Exceeding these ratings may damage the device.
2) The maximum allowable power dissipation is a function of the maximum junction temperature $T_{j}(\mathrm{MAX})$, the junction-toambient thermal resistance $\theta_{\mathrm{JA}}$, and the ambient temperature $\mathrm{T}_{\mathrm{A}}$. The maximum allowable continuous power dissipation at any ambient temperature is calculated by $\mathrm{P}_{\mathrm{D}}(\mathrm{MAX})=\left(\mathrm{T}_{J}(\mathrm{MAX})-\right.$ $\left.\mathrm{T}_{\mathrm{A}}\right) / \theta_{\mathrm{JA}}$. Exceeding the maximum allowable power dissipation will cause excessive die temperature, and the regulator will go into thermal shutdown. Internal thermal shutdown circuitry protects the device from permanent damage.
3) The device is not guaranteed to function outside of its operating conditions.
4) Measured on JESD51-7, 4-layer PCB.

## ELECTRICAL CHARACTERISTICS

$V_{D D}=V_{B S T}-V_{S W}=12 V, V_{S S}=V_{S W}=0 V$, No load at DRVH and DRVL, $T_{A}=+25^{\circ} \mathrm{C}$, unless otherwise noted.

| Parameter | Symbol | Condition | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Supply Currents |  |  |  |  |  |  |
| VDD quiescent current | $\mathrm{I}_{\text {DDQ }}$ | $\mathrm{INL}=\mathrm{INH}=0$ |  | 100 | 150 | $\mu \mathrm{A}$ |
| VDD operating current | $\mathrm{I}_{\text {DDO }}$ | $\mathrm{fsw}=500 \mathrm{kHz}$ |  | 9 |  | mA |
| Floating driver quiescent current | $\mathrm{I}_{\text {BSTQ }}$ | $\mathrm{INL}=\mathrm{INH}=0$ |  | 60 | 90 | $\mu \mathrm{A}$ |
| Floating driver operating current | $\mathrm{I}_{\text {BSTO }}$ | fsw $=500 \mathrm{kHz}$ |  | 7.5 |  | mA |
| Leakage current | lık | BST $=$ SW $=100 \mathrm{~V}$ |  | 0.05 | 1 | $\mu \mathrm{A}$ |
| Inputs |  |  |  |  |  |  |
| INL/INH High |  |  |  | 2 | 2.4 | V |
| INL/INH Low |  |  | 1 | 1.4 |  | V |
| INL/INH internal pull-down resistance | $\mathrm{R}_{\text {IN }}$ |  |  | 185 |  | k ת |
| Under Voltage Protection |  |  |  |  |  |  |
| VDD rising threshold | $V_{\text {DDR }}$ |  | 8.1 | 8.4 | 8.8 | V |
| VDD hysteresis | $V_{\text {DDH }}$ |  |  | 0.5 |  | V |
| (BST-SW) rising threshold | $V_{\text {BSTR }}$ |  | 6.9 | 7.3 | 7.7 | V |
| (BST-SW) hysteresis | $\mathrm{V}_{\text {BSTH }}$ |  |  | 0.55 |  | V |
| Bootstrap Diode |  |  |  |  |  |  |
| Bootstrap diode VF @ 100 $\mu \mathrm{A}$ | $\mathrm{V}_{\text {F1 }}$ |  |  | 0.5 |  | V |
| Bootstrap diode VF @ 100mA | $\mathrm{V}_{\mathrm{F} 2}$ |  |  | 0.95 |  | V |
| Bootstrap diode dynamic R | $\mathrm{R}_{\mathrm{D}}$ | @ 100mA |  | 2 |  | $\Omega$ |
| Low Side Gate Driver |  |  |  |  |  |  |
| Low level output voltage | Voll | $\mathrm{I}_{0}=100 \mathrm{~mA}$ |  | 0.08 |  | V |
| High level output voltage to rail | $\mathrm{V}_{\mathrm{OHL}}$ | $\mathrm{I}_{0}=-100 \mathrm{~mA}$ |  | 0.23 |  | V |
| Peak pull-up current | Іонц | $\mathrm{V}_{\mathrm{DRVL}}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}=12 \mathrm{~V}$ |  | 3 |  | A |
|  |  | $\mathrm{V}_{\text {DRVL }}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}=16 \mathrm{~V}$ |  | 4.7 |  | A |
| Peak pull-down current | loll | $\mathrm{V}_{\text {DRVL }}=\mathrm{V}_{\mathrm{DD}}=12 \mathrm{~V}$ |  | 4.5 |  | A |
|  |  | $\mathrm{V}_{\mathrm{DRVL}}=\mathrm{V}_{\mathrm{DD}}=16 \mathrm{~V}$ |  | 6 |  | A |
| Floating Gate Driver |  |  |  |  |  |  |
| Low level output voltage | $\mathrm{V}_{\text {OLH }}$ | $\mathrm{I}_{\mathrm{O}}=100 \mathrm{~mA}$ |  | 0.08 |  | V |
| High level output voltage to rail | $\mathrm{V}_{\text {ОНн }}$ | $\mathrm{I}_{0}=-100 \mathrm{~mA}$ |  | 0.23 |  | V |
| Peak pull-up current | Іонн | $\mathrm{V}_{\text {DRVH }}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}=12 \mathrm{~V}$ |  | 2.6 |  | A |
|  |  | $\mathrm{V}_{\text {DRVH }}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}=16 \mathrm{~V}$ |  | 4 |  | A |
| Peak pull-down current | l (\%h | $\mathrm{V}_{\text {DRVH }}=\mathrm{V}_{\text {DD }}=12 \mathrm{~V}$ |  | 4.5 |  | A |
|  |  | $\mathrm{V}_{\text {DRVH }}=\mathrm{V}_{\mathrm{DD}}=16 \mathrm{~V}$ |  | 5.9 |  | A |

## ELECTRICAL CHARACTERISTICS (continued)

$V_{D D}=V_{B S T}-V_{S W}=12 \mathrm{~V}, V_{S S}=V_{S W}=0 V$, No load at DRVH and DRVL, $T_{A}=25^{\circ} \mathrm{C}$, unless otherwise noted.

| Parameter | Symbol | Condition | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Switching Spec. --- Low Side Gate Driver |  |  |  |  |  |  |
| Turn-off propagation delay INL falling to DRVL falling | T ${ }_{\text {DLFF }}$ |  |  | 20 |  | ns |
| Turn-on propagation delay INL rising to DRVL rising | $\mathrm{T}_{\text {DLRR }}$ |  |  | 20 |  |  |
| DRVL rise time |  | $\mathrm{C}_{\mathrm{L}}=2.2 \mathrm{nF}$ |  | 15 |  | ns |
| DRVL fall time |  | $\mathrm{C}_{\mathrm{L}}=2.2 \mathrm{nF}$ |  | 9 |  | ns |
| Switching Spec. --- Floating Gate Driver |  |  |  |  |  |  |
| Turn-off propagation delay INL falling to DRVH falling | $\mathrm{T}_{\text {DhFF }}$ |  |  | 20 |  | ns |
| Turn-on propagation delay INL rising to DRVH rising | $\mathrm{T}_{\text {DHRR }}$ |  |  | 20 |  | ns |
| DRVH rise time |  | $\mathrm{C}_{\mathrm{L}}=2.2 \mathrm{nF}$ |  | 15 |  | ns |
| DRVH fall time |  | $\mathrm{C}_{\mathrm{L}}=2.2 \mathrm{nF}$ |  | 12 |  | ns |
| Switching Spec. --- Matching |  |  |  |  |  |  |
| Floating driver turn-off to low side drive turn-on | $\mathrm{T}_{\text {mon }}$ |  |  | 1 | 5 | ns |
| Low side driver turn-off to floating driver turn-on | $\mathrm{T}_{\text {moff }}$ |  |  | 1 | 5 | ns |
| Minimum input pulse width that changes the output | $\mathrm{T}_{\text {PW }}$ |  |  |  | $50^{(5)}$ | ns |
| Bootstrap diode turn-on or turnoff time | $\mathrm{T}_{\mathrm{BS}}$ |  |  | $10^{(5)}$ |  | ns |
| Thermal shutdown |  |  |  | 150 |  | ${ }^{\circ} \mathrm{C}$ |
| Thermal shutdown hysteresis |  |  |  | 25 |  | ${ }^{\circ} \mathrm{C}$ |

## Note:

5) Guaranteed by design.


Figure 1—Timing Diagram

PIN FUNCTIONS

| Pin \# | Name | Description |
| :---: | :---: | :--- |
| 1 | VDD | Supply input. This pin supplies power to all the internal circuitry. Place a decoupling <br> capacitor to ground close to this pin to ensure stable and clean supply. |
| 2 | BST | Bootstrap. This is the positive power supply for the internal floating high-side MOSFET <br> driver. Connect a bypass capacitor between this pin and SW pin. |
| 3 | DRVH | Floating driver output. |
| 4 | SW | Switching node. |
| 5 | INH | Control signal input for the floating driver. |
| 6 | INL | Control signal input for the low side driver. |
| 7 | VSS, <br> exposed pad | Chip ground. Connect exposed pad to VSS for proper thermal operation. |
| 8 | DRVL | Low side driver output. |

## TYPICAL PERFORMANCE CHARACTERISTICS

$V_{D D}=12 \mathrm{~V}, \mathrm{~V}_{\mathrm{SS}}=\mathrm{V}_{\mathrm{SW}}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$, unless otherwise noted.



High Level Output
Voltage vs. Temperature


Low Level Output
Voltage vs. Temperature




## Bootstrap Diode I-V Characteristic



Propagation Delay vs. Temperature


## TYPICAL PERFORMANCE CHARACTERISTICS (continued)

$\mathrm{V}_{\mathrm{DD}}=12 \mathrm{~V}, \mathrm{~V}_{\mathrm{SS}}=\mathrm{V}_{\mathrm{SW}}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$, unless otherwise noted.
Peak Current vs.
Vdd Voltage


Turn-on Propagation Delay
Turn-off Propagation Delay
Gate Drive Matching $\mathrm{T}_{\text {MOFF }}$





Drive Rise Time 2.2nF Load


Drive Fall Time 2.2nF Load


## BLOCK DIAGRAM



Figure 2—Function Block Diagram

## APPLICATION

The input signals INH and INL can be controlled independently. If both INH and INL control the high-side MOSFET and low-side MOSFET of the same bridge, then users must avoid shoot through by


No Shoot through

setting sufficient dead time between INH and INL low, and vice versa. See Figure 3 below. Dead time is defined as the time interval between INH low and INL low.

Shoot through
(No dead time)

INH


INL


No Shoot through


Figure 3-Shoot-Through Timing Diagram

## REFERENCE DESIGN CIRCUITS

## Half Bridge Converter

The MP18024 drives the MOSFETS with alternating signals (with dead time) in half-bridge converter topology. Therefore, from the PWM
controller drives INH and INL with alternating signals The input voltage can go up to 100 V .

Input Voltage
Up to 100 V


Figure 4-Half Bridge Converter

## Two-Switch Forward Converter

In two-switch forward converter topology, both MOSFETs are turned on and off simultaneously. The input signal (INH and INL) comes from a PWM controller that senses the output voltage (and output current during current-mode control).

The Schottky diodes clamp the reverse swing of the power transformer and must be rated for the input voltage. The input voltage can go up to 100 V


Figure 5-Two-Switch Forward Converter

## Active-Clamp Forward Converter

In active-clamp-forward converter topology, the MP18024 drives the MOSFETs with alternating signals. The high-side MOSFET, in conjunction with Creset, is used to reset the power transformer in a lossless manner.

This topology lends itself well to run at duty cycles exceeding $50 \%$. The device may not be able to run at 100 V with this topology.


Figure 6—Active-Clamp Forward Converter

## PACKAGE INFORMATION

SOIC8E


NOTICE: The information in this document is subject to change without notice. Users should warrant and guarantee that third party Intellectual Property rights are not infringed upon when integrating MPS products into any application. MPS will not assume any legal responsibility for any said applications.

